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AMENDMENT

To : Examiner of the Patent Office

1. Identification of the International Application

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4. Item to be Amended

Claims

5. Subject Matter of Correction

Claims 10, 27, 32, 37 and 39 should be amended as per the attached sheets.

Claim 10 is amended to define the first and second pulse voltages.

Claim 27 is amended to have the claim more distinct from Figure 3 in D4.

Claim 32 is amended to have the claim more distinct from D2.

Claim 37 is amended to have the claim more distinct from D2.

Claim 39 is amended to be more descriptive of the relation between the first, second and third terminals and the first and second variable resistance means.

6. List of Attached Documents

Pages 58, 62-1, 62-2, 63, 64-1, 64-2 and 65 of the Claims

10. (amended) The memory device of claim 1, wherein at a first time a first pulse voltage of the first polarity is applied to the first terminal and the third terminal and a second pulse voltage of polarity opposite to the first polarity is applied to the second terminal, and at a second time the second pulse voltage is applied to the third terminal and the second terminal and the first pulse voltage is applied to the first terminal.

11. The memory device of claim 1, wherein a voltage at the third terminal is output with a first potential applied to the first terminal and a second potential applied to the second terminal.

12. A memory device whose resistance value changes in accordance with a pulse voltage applied thereto, the device comprising:

a plurality of memory cells, each memory cell comprising:

a transistor formed on a semiconductor substrate and having a source, a drain and a gate;

an insulating layer formed over the transistor;

a variable resistance layer formed over the insulating layer; and

two electrodes formed on the variable resistance layer,

wherein at least one of the drain and the source of the transistor are electrically connected to the two electrodes.

13. The memory device according to claim 12, wherein each memory cell further comprises:

a conductive layer formed on the insulating layer; and

a contact plug electrically connecting the at least one of the drain and the

27. (amended) A memory circuit, comprising:

a first memory block connected between a node receiving a variable power supply and a first bit line;

a first block-selecting transistor connected in series with the first memory block
5 between the first bit line and the node;

a second memory block connected between the node receiving the variable power supply and a second bit line different from the first bit line; and

a second block-selecting transistor connected in series with the second memory block between the second bit line and the node,

10 wherein each of the first and second memory blocks includes a plurality of memory cells connected in series, and

each of the plurality of memory cells includes

a variable resistor connected between a first terminal and a second terminal and whose resistance value changes in response to a pulse voltage
15 applied between the first terminal and the second terminal, and

a transistor connected in parallel with the variable resistor between the first terminal and the second terminal.

28. The memory circuit of claim 27, wherein during writing of data,

20 the first block-selecting transistor and the second block-selecting transistor are turned ON,

a transistor in first a memory cell of the plurality of memory cells in the first memory block is turned OFF and a transistor in each memory cell other than the first memory cell of the plurality of memory cells in the first memory block is turned ON, and

25 a transistor in a second memory cell of the plurality of memory cells in the second

memory block is turned OFF and a transistor in each memory cell other than the second memory cell of the plurality of memory cells in the second memory block is turned ON.

29. The memory circuit of claim 28, wherein during writing of data, a pulse voltage for increasing the resistance value of a variable resistor included in the first memory cell is applied between the first node and the second node, and a pulse voltage for
5 reducing the resistance value of a variable resistor included in the second memory cell is applied between the second node and the third node.

30. The memory circuit of claim 27, wherein during reading of data,
the first block-selecting transistor and the second block-selecting transistor are
10 turned ON,

a transistor in a first memory cell of the plurality of memory cells in the first memory circuit is turned OFF and a transistor included in each memory cell other than the first memory cell of the plurality of memory cells in the first memory block is turned ON,
and

15 a transistor in a second memory cell of the plurality of memory cells in the second memory circuit is turned OFF and a transistor in each memory cell of the plurality of memory cells other than the second memory cell is turned ON.

31. The memory circuit of claim 30, wherein during reading of data, a voltage
20 at the second node is detected with a given voltage applied between the first node and the third node.

32. (amended) A method for writing of data in a variable resistance memory cell having at least three terminals and for resetting the variable resistance memory cell,
25 comprising the steps of:

applying a first potential to two terminals of the at least three terminals of the variable resistance memory cell;

applying a second potential to a terminal other than the two terminals of the variable resistance memory cell;

5 changing a resistance value of a first variable resistance device of the variable resistance memory cell; and

changing a resistance value of a second variable resistance device of the variable resistance memory cell in a direction opposite to that of the first variable resistance memory device.

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33. The method of claim 32, wherein during data writing, the second potential has a first polarity and during a resetting operation, the second potential has a second polarity opposite of the first polarity.

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34. The method of claim 32, further comprising the steps of:

changing a resistance value of a first variable resistance device of the variable resistance memory cell;

changing a resistance value of a second variable resistance device of the variable resistance memory cell in a direction opposite to that of the first variable resistance memory device.

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35. The method of claim 32, wherein

the step of applying the first potential comprises applying a first pulse of the first potential at a first time, and

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the step of applying the second potential comprises applying a second pulse of the

second potential at the first time having a second polarity opposite of a first polarity of the first pulse.

36. The method of claim 35, further comprising the steps of:

5 applying a third potential of the second polarity to two terminals of the at

least three terminals of the variable resistance memory cell at a second time; and

applying a fourth potential of the first polarity to a terminal other than the two terminals of the variable resistance memory cell at the second time.

5 37. (amended) A method for reading of data in a variable resistance memory cell having at least three terminals, comprising the steps of:

providing the variable resistance memory cell having a common access transistor connected in series to an output node and a first variable resistance device and a second variable resistance device connected in parallel to the output node;

10 applying a ground voltage to a terminal of the first variable resistance device;

applying a reproducing voltage that is lower than a recording voltage to a terminal of the second variable resistance device;

outputting a voltage from the output terminal.

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38. The method for reading of data according to claim 37, wherein the voltage output has multiple values corresponding to a number of voltage pulses applied in a recording operation.

20 39. (amended) A memory cell for storing at least one bit of data, comprising:

first variable resistance means for changing resistance in accordance with a polarity of a pulse voltage between a first terminal and a third terminal; and

second variable resistance means for changing resistance in a direction opposite to a direction of change of the first variable resistance means in accordance with a polarity of
25 a pulse voltage between the third terminal and a second terminal.